

IWACIII2021 Call for Papers

The 7th International Workshop on Advanced Computational Intelligence and Intelligent Informatics
Beijing, China, Oct.31-Nov.3, 2021

The 7th International Workshop on Advanced Computational Intelligence and Intelligent Informatics (IWACIII 2021) is organized by Beijing Institute of Technology, Beijing, P. R. China. IWACIII 2021 is an international conference that provides a forum for scientists and engineers over the world to present their own theoretical results and techniques in the field of computational intelligence and intelligent informatics. The past conference proceedings have been indexed in EI since 2009. Selected excellent papers will be published in the special issue of JACIII (Journal of Advanced Computational Intelligence and Intelligent Informatics, ESCI/SCOPUS/EI indexed). Taking this opportunity, we sincerely welcome our colleagues worldwide to join us for this workshop. Please visit the conference website <http://iwaciii2021.bit.edu.cn/> for further information.

Technical topics of IWACIII2021 include but are not limited to:

Neural Networks	Fuzzy Systems	Evolutionary Computing	Learning Systems	Swarm Intelligence
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Soft Computing	Data Mining	Data Fusion	Knowledge Discovery in Data	Network Security
Signal and Image Processing	Control Theory and Applications	Intelligent Control	Motion Control	Network-based Control
Human-Computer Interface	Robotics	Mechatronics	Intelligent Transportation Systems	Applications of AI



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Paper Submission

All manuscripts must be submitted electronically in PDF format before the deadline. Only English manuscripts are acceptable. The initial version of each paper cannot exceed 8 pages. The camera-ready version of each accepted paper is also up to 8 pages in total, but each page in excess of 6 will incur an extra charge. Manuscripts should be on A4 sized paper (210 mm x 297 mm), in two-column format, with top and bottom margins of 25 mm, left and right margins of 20 mm, column width of 80 mm, and inter-column gap of 5 mm. All figures and tables should be clearly visible, and the paper template in LaTeX or Word can be downloaded from the conference website or <https://cms.amss.ac.cn/resources.php#iwaciii>. A complete paper should be submitted via <https://cms.amss.ac.cn> which is an online conference paper management system. Selected papers will also be published in the special issue of JACIII.

Important Dates

Paper Submission Deadline	-----	June 1, 2021	Notification of Acceptance	-----	Jul. 1, 2021
Final Camera-Ready Paper Due	-----	Aug. 1, 2021	Conference Period	-----	Oct.31-Nov.3, 2021

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